Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	798	"proximity head"	US-PGPUB; USPAT	OR	OFF	2006/05/15 14:17
L2	183	1 and (wafer semiconductor substrate)	US-PGPUB; USPAT	OR	OFF	2006/05/15 13:59
L3	9	("proximity head" same heat\$3)and (wafer semiconductor substrate)	US-PGPUB; USPAT	OR	OFF	2006/05/15 12:15
L4	8	("3128158" "4294021" "4736529" "5423248").PN. OR ("5553394").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2006/05/15 12:20
L5	20	(mikhaylichenko delarios).in.	US-PGPÜB; USPAT; USOCR	OR	OFF	2006/05/15 12:23
L6	262	156/345.17 156/345.18 156/345.37 134/106	US-PGPUB; USPAT; USOCR	OR	OFF	2006/05/15 12:23
L7	35	("3834083" "3900866" "4113492" "4314022" "4393807" "4510176" "4518678" "4557785" "4576796" "4611553" "4668334" "4685975" "4732785" "4790262" "4838979" -"4886728" "4899685" "5013586" "5103102" "5151219" "5178989" "5238713" "5279926" "5289222" "5294257" "5358740" "5362608" "5378511" "5444921" "5474807" "5580607" "5608943" "5705223" "5759427" "5952050").PN. OR ("6793764"). URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2006/05/15 12:37
L8	20	"5103102"	US-PGPUB; USPAT; USOCR	OR	OFF	2006/05/15 12:41
L9	2026	438/745	US-PGPUB; USPAT; USOCR	OR	OFF	2006/05/15 12:41
L10	813	9 and heat\$3	US-PGPUB; USPAT; USOCR	OR	OFF	2006/05/15 12:41
L11	3	("20020067400" "6365531" "6599582").PN. OR ("6977222"). URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2006/05/15 13:11
L12	717	261/142	US-PGPUB; USPAT; USOCR	OR	OFF	2006/05/15 13:12

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L13	122	12 and (wafer semiconductor substrate)	US-PGPUB; USPAT; USOCR	OR	OFF	2006/05/15 13:14
L14	60	13 and (suc\$3 vacuum)	US-PGPUB; USPAT; USOCR	OR	OFF	2006/05/15 13:17
L15	1530	muffle and (wafer semiconductor substrate)	US-PGPUB; USPAT; USOCR	OR	OFF	2006/05/15 13:17
L16	594	(muffle with (heat\$3 thermal)) and (wafer semiconductor substrate)	US-PGPUB; USPAT; USOCR	OR	OFF	2006/05/15 13:24
L17	18967	(heat\$3 same ((vacuum suc\$3) with (fluid supply liquid gas))) and (wafer semiconductor substrate)	US-PGPUB; USPAT; USOCR	OR	OFF	2006/05/15 13:25
L18	8341	(heat\$3 same ((vacuum suc\$3) with (fluid supply liquid gas))) same (wafer semiconductor substrate)	US-PGPUB; USPAT; USOCR	OR	OFF	2006/05/15 13:25
L19	3812	(heat\$3 with((vacuum suc\$3) with (fluid supply liquid gas))) same (wafer semiconductor substrate)	US-PGPUB; USPAT; USOCR	OR	OFF	2006/05/15 13:25
L20	2538	(heat\$3 with((vacuum suc\$3) with (fluid supply liquid gas))) with (wafer semiconductor substrate)	US-PGPUB; USPAT; USOCR	OR	OFF	2006/05/15 13:26
L21	850	(heat\$3 with((vacuum suc\$3) with (fluid supply liquid gas))) with (wafer semiconductor)	US-PGPUB; USPAT; USOCR	OR	OFF	2006/05/15 13:26
L22	7	(("4,838,289") or ("5,271,774") or ("5,705,223") or ("5,945,351") or ("5,997,653") or ("6,398,975") or ("6,491,764")).PN.	USPAT	OR	OFF	2006/05/15 14:03

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L23	33	(("3,953,265") or ("4,086,870") or ("4,444,492") or ("4,838,289") or ("5,102,494") or ("5,180,431") or ("5,271,774") or ("5,294,257") or ("5,343,234") or ("5,860,642") or ("5,705,223") or ("5,882,433") or ("5,893,004") or ("5,945,351") or ("5,975,098") or ("5,989,478") or ("5,997,653") or ("6,108,932") or ("6,341,998") or ("6,391,166") or ("6,398,975") or ("6,417,117") or ("6,474,786") or ("6,514,570") or ("6,616,772")).PN. or ("2002/0051644) or (2002/0121290) or (2003/0091745) or (2004/0060581) or (2004/0069319) or (2004/0182422) or (2004/0182422) or (2005/0148197)).CCLS.	US-PGPUB; USPAT	OR	OFF	2006/05/15 14:11
L24	0	((2002/0007869) or (2002/0051644) or (2002/0121290) or (2002/0125212) or (2003/0091745) or (2003/0092264) or (2003/0138968) or (2004/0060573) or (2004/0060581) or (2004/0069319) or (2004/0069326) or (2004/0178060) or (2004/0182422) or (2005/0148197)).CCLS.	US-PGPUB; USPAT	OR .	OFF	2006/05/15 14:07
L25	9	"2002/0007869" "2002/0051644" "2002/0121290" "2002/0125212" "2003/0091745" "2003/0092264" "2003/0138968" "2004/0060573" "2004/0060581" "2004/0069319" "2004/0069326" "2004/0178060" "2004/0182422" "2005/0148197"	US-PGPUB; USPAT	OR	OFF	2006/05/15 14:09
L26	57	("3437543" "3489608" "3597289" "3765984" "3841930" "3874959").PN. OR ("3953265"). URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2006/05/15 14:13
L27	3644	proximity adj4 head	US-PGPUB; USPAT	OR	OFF	2006/05/15 14:18
L28	100	27 same (wafer semiconductor)	US-PGPUB; USPAT	OR	OFF	2006/05/15 14:18

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L29	115	(proximity adj4 head) with (heat\$3)	US-PGPUB; USPAT	OR	OFF	2006/05/15 14:24
L30	2	29 same (wafer semiconductor)	US-PGPUB; USPAT	OR	OFF	2006/05/15 14:18
L31	0	"9916109".ipc.	US-PGPUB; USPAT	OR	OFF	2006/05/15 14:24
L32	7	"99/16109"	US-PGPUB; USPAT	OR	OFF	2006/05/15 14:29
L33	6	"0232825"	US-PGPUB; USPAT	OR	OFF	2006/05/15 14:29
L34	1	"03014416"	US-PGPUB; USPAT	OR	OFF	2006/05/15 14:29
L35	7	"022280330" "02309638" "11350169"	US-PGPUB; USPAT	OR	OFF	2006/05/15 14:29
L36	11	7 AND HEAT\$3	US-PGPUB; USPAT	OR	OFF	2006/05/15 14:28
L37	0	35 AND HEAT\$3	US-PGPUB; USPAT	OR	OFF	2006/05/15 14:28
L38	0	"99/16109"	EPO; JPO; DERWENT	OR	OFF	2006/05/15 14:29
L39	17	"0232825"	EPO; JPO; DERWENT	OR	OFF	2006/05/15 14:29
L40	1	"03014416"	EPO; JPO; DERWENT	OR	OFF	2006/05/15 14:29
L41	6	"022280330" "02309638" "11350169"	EPO; JPO; DERWENT	OR	OFF	2006/05/15 14:29
L42	24	39 40 41	EPO; JPO; DERWENT	OR	OFF	2006/05/15 14:29